In the Claims:

- 1. **(currently amended)** A process for the production of a strongly adherent metal coating on aninorganic or organic a glass, ceramic or polymeric substrate, wherein
- a) a low temperature plasma treatment, a corona discharge treatment or a flame treatment is carried out on the inorganic or organic glass, ceramic or polymeric substrate,
- b) one or more photoinitiators or mixtures of photoinitiators with monomers or/and oligomers, containing at least one ethylenically unsaturated group, or solutions, suspensions or emulsions of the afore-mentioned substances, are applied to the inorganic or organic substrate to produce a layer which is optionally dried,
- c) <u>irradiating</u> the layer of step b) is optionally dried and is irradiated with electromagnetic waves; with from 1 to 1000 mJ /cm² of UV/Vis light having wavelengths from 150 to 700 nm to fix the one or more photoinitiators in the layer of step b); and, after said irradiation,
- d) on the substrate so precoated with photoinitiator a metal, half-metal or metal oxide is deposited from the gas_phase
- wherein a coated substrate comprising a glass, ceramic or polymeric substrate affixed to the irradiated layer of step b), which layer of step b) is affixed to a deposited metal, half-metal or metal oxide layer is obtained.
- 2. **(currently amended)** A process according to claim 1, wherein <u>in step d</u>) an irradiation with electromagnetic waves is carried out, either while depositing the metal, half-metal or metal oxide from the gasphase or after the deposition.
- 3. **(original)** A process according to claim 1, wherein the photoinitiator is a compound or combination of compounds from the classes of benzoins, benzil ketals, acetophenones, hydroxyalkylphenones, aminoalkylphenones, acylphosphine oxides, acylphosphine sulfides, acyloxyiminoketones, peroxy compounds, halogenated acetophenones, phenylglyoxylates, dimeric phenylglyoxalates, benzophenones, oximes and oxime esters, thioxanthones, thiazolines, ferrocenes, coumarins, dinitrile compounds, titanocenes, sulfonium salts, iodonium salts, diazonium salts, onium salts, borates, triazines, bisimidazoles, polysilanes and dyes, and also corresponding coinitiators and/or sensitisers.

4. (original) A process according to claim 1, wherein the photoinitiator is a compound of formula I or la

$$(RG)-A-(IN)$$
 (I), $(IN)-A-(RG')-A-(IN)$ (Ia),

wherein

(IN) is a photoinitiator base structure;

A is a spacer group or a single bond;

(RG) is hydrogen or at least one functional ethylenically unsaturated group; and

(RG') is a single bond or a divalent radical that contains at least one functional ethylenically unsaturated group, or is a trivalent radical.

5. (original) A process according to claim 4, wherein in the compound of formula I or Ia

(IN) is a photoinitiator base structure of formula (II) or (III)

 R_1 is a group (A), (B), (C) or (III)

$$R_{5}$$

$$R_{2}$$

$$(A), \quad -CR_{6}R_{7}R_{8} \quad (B)$$

$$Q$$

$$-U - (OCH_{2}CH_{2})_{n}OR_{11} \quad (C);$$

n is a number from 0 to 6;

 R_2 is hydrogen, C_1 - C_{12} alkyl, halogen, the group (RG)-A- or, when R_1 is a group (A), two radicals

 R_2 in the ortho-position to the carbonyl group may also together be -S- or $\frac{|\cdot|}{C}$

 R_3 and R_4 are each independently of the other C_1 - C_6 alkyl, C_1 - C_6 alkanoyl, phenyl or benzoyl, the radicals phenyl and benzoyl each being unsubstituted or substituted by halogen, C_1 - C_6 alkyl, C_1 - C_6 alkylthio or by C_1 - C_6 alkoxy;

 R_5 is hydrogen, halogen, C_1 - C_{12} alkyl or C_1 - C_{12} alkoxy or the group (RG)-A-;

 R_7 and R_8 are each independently of the other hydrogen, C_1 - C_{12} alkyl, C_2 - C_{12} alkenyl, C_1 - C_{12} alkoxy, phenyl or benzyl or R_7 and R_8 together are C_2 - C_6 alkylene;

 R_9 is hydrogen, C_1 - C_6 alkyl or C_1 - C_6 alkanoyl;

 R_{10} is hydrogen, C_1 - C_{12} alkyl or phenyl;

 \mathbf{R}_{11} is C_1 - C_4 alkyl or

 X_1 is oxygen or sulfur.

6. (previously presented) A process according to claim 5, wherein in the compound of formula I or Ia (RG) is $R_cR_bC=CR_a$ -;

$$\begin{array}{c|c} & CH_2R_a\\ & || & \\ --C-C-- \\ & | \\ R_b \end{array}$$
 (RG') is or , and

 R_a , R_b and R_c are each independently of the other hydrogen or $C_1\text{-}C_6$ alkyl.

- 7. **(previously presented)** A process according to claim 1, wherein the photoinitiator(s) or mixtures thereof with monomers or oligomers are used in combination with one or more liquids in the form of solutions, suspensions and emulsions.
- 8. (previously presented) A process according to claim 1, wherein an inert gas or a mixture of inert gas with reactive gas is used as the plasma gas.
- 9. (original) A process according to claim 8, wherein air, H_2 , CO_2 , He, Ar, Kr, Xe, N_2 , O_2 or H_2O are used singly or in the form of a mixture.
- 10. (previously presented) A process according to claim 1, wherein the photoinitiator layer applied has a layer thickness of up to 500 nm.
- 11. **(original)** A process according to claim 1, wherein process step b) is carried out immediately after process step a) or within 24 hours after process step a).

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- 12. **(previously presented)** A process according to claim 1, wherein the concentration of photo-initiator or photoinitiators in process step b) is from 0.01 to 99.5 %.
- 13. **(original)** A process according to claim 1, wherein process step c) is carried out immediately after process step b) or within 24 hours after process step b).
- 14. **(original)** A process according to claim 1, wherein drying in process step c) is effected in ovens, with hot gases, heated rollers or IR or microwave radiators or by absorption.
- 15. **(previously presented)** A process according to claim 1, wherein irradiation in process step c) and/or d) is effected with a source that emits electromagnetic waves of wavelengths in the range from 200 nm to 700 nm, or by electron beams.
- 16-18. (cancelled)
- 19. (withdrawn) A strongly adherent coating obtained by a process according to claim 1.
- 20. (withdrawn) A strongly adherent coating obtained by a process according to claim 2.
- 21. **(previously presented)** A process according to claim 2, wherein an inert gas or a mixture of inert gas with reactive gas is used as the plasma gas.